



Power MOSFETS

DATASHEET

LM45010NHM8A

N-Channel
Enhancement Mode MOSFET

- Leadpower-semi CO., LTD.
- sales@leadpower-semi.com
- (03) 6577339 FAX : (03) 6577229
- www.leadpower-semi.com



Quality Management Systems
ISO 9001:2015 Certificate

N-Channel Enhancement Mode MOSFET

Pin Description

LFPAK56		Symbol	Symbol	N-Channel	Unit
Top view	Bottom view			V _{DSS}	V
				R _{DS(ON)-MAX}	mΩ
				I _D	A

Feature

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant & Halogen-Free
- 100% UIS and Rg Tested

Product Summary

Applications

- DC-to-DC converters
- Switch Mode Power Supply

Ordering Information

Orderable Part Number	Package Type	Form	Shipping	Marking
LM45010NHM8A	LFPAK56	Tape & Reel	4000 / Tape & Reel	45010 <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/> <input type="checkbox"/>

Note : = Lot Code

Absolute Maximum Ratings ($T_J=25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
V _{DSS}	Drain-Source Voltage	45	V
V _{GSS}	Gate-Source Voltage	±20	
T _J	Maximum Junction Temperature	175	°C
T _{STG}	Storage Temperature Range	-55 to 175	°C
I _S	Diode Continuous Forward Current	T _c =25°C 108	A
I _{DM} ⁽¹⁾	Pulse Drain Current Tested	T _c =25°C 807	A
I _D	Continuous Drain Current	T _c =25°C 323	A
		T _c =100°C 228	
P _D	Maximum Power Dissipation	T _c =25°C 166	W
		T _c =100°C 83	
I _D	Continuous Drain Current	T _A =25°C 46	A
		T _A =70°C 38	
P _D	Maximum Power Dissipation	T _A =25°C 3.3	W
		T _A =70°C 2.3	
I _{AS} ⁽²⁾	Avalanche Current, Single pulse	L=0.1mH 55	A
		L=0.5mH 30	
E _{AS} ⁽²⁾	Avalanche Energy, Single pulse	L=0.1mH 151	mJ
		L=0.5mH 225	

Thermal Characteristics

Symbol	Parameter	Rating	Unit
R _{θJC}	Thermal Resistance-Junction to Case	Steady State 0.9	°C/W
R _{θJA} ⁽³⁾	Thermal Resistance-Junction to Ambient	Steady State 45	°C/W

Note ① : Max. current is limited by junction temperature

Note ② : UIS tested and pulse width are limited by maximum junction temperature 175°C

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz

LM45010NHM8A

N-Channel Electrical Characteristics (T_J=25°C Unless Otherwise Noted)

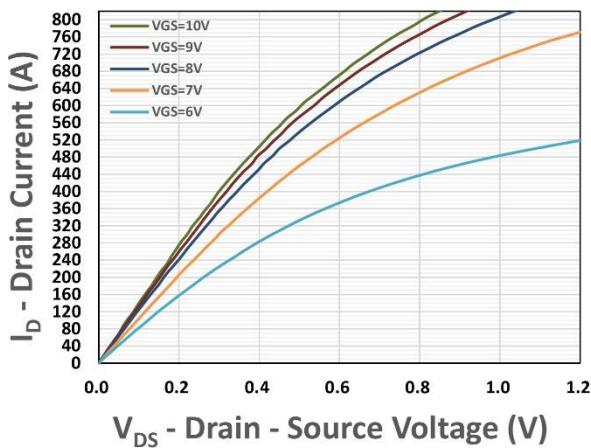
Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V, I _{DS} =250uA	45	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	V _{DS} =36V V _{GS} =0V	-	-	1	uA
V_{GS(th)}	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =250uA	2.4	2.9	3.5	V
I_{GSS}	Gate Leakage Current	V _{GS} =±20V, V _{DS} =0V	-	-	±100	nA
R_{DS(on)}⁽⁴⁾	Drain-Source On-state Resistance	V _{GS} =10V, I _{DS} =50A	-	0.66	0.8	mΩ
g_{fs}	Forward Transconductance	V _{DS} =5V, I _{DS} =10A	-	44	-	S
Dynamic Characteristics⁽⁵⁾						
R_G	Gate Resistance	V _{GS} =0V, V _{DS} =0V, Freq.=1MHz	-	0.6	-	Ω
C_{iss}	Input Capacitance	V _{GS} =0V, V _{DS} =20V, Freq.=1MHz	-	6281	-	pF
C_{oss}	Output Capacitance		-	2159	-	
C_{rss}	Reverse Transfer Capacitance		-	103	-	
t_{d(on)}	Turn-on Delay Time	V _{GS} =10V, V _{DS} =25V, I _D =1A, R _{GEN} =1Ω	-	20	-	nS
t_r	Turn-on Rise Time		-	11	-	
t_{d(off)}	Turn-off Delay Time		-	48	-	
t_f	Turn-off Fall Time		-	100	-	
Q_g	Total Gate Charge	V _{GS} =10V, V _{DS} =25V, I _D =20A	-	83	-	nC
Q_{gs}	Gate-Source Charge		-	25	-	
Q_{gd}	Gate-Drain Charge		-	12	-	
Source-Drain Characteristics						
V_{SD}⁽⁴⁾	Diode Forward Voltage	I _{SD} =10A, V _{GS} =0V	-	0.74	-	V
t_{rr}	Reverse Recovery Time	I _F =10A, V _R =25V dI _F /dt=100A/μs	-	68	-	nS
Q_{rr}	Reverse Recovery Charge		-	98	-	nC

Note ④ : Pulse test (pulse width≤300us, duty cycle≤2%).

Note ⑤ : Guaranteed by design, not subject to production testing.

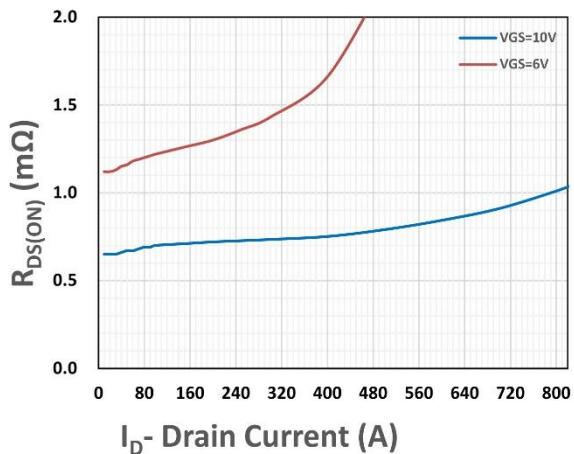
LM45010NHM8A

N-Channel Typical Characteristics



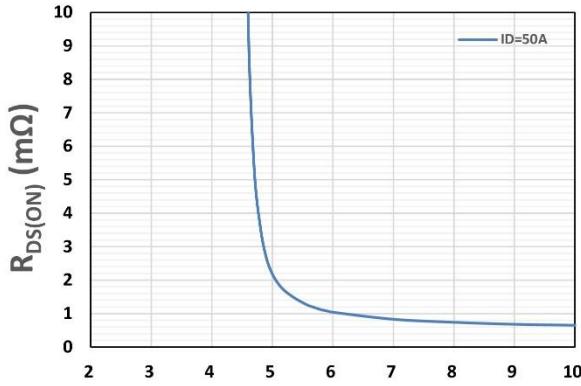
V_{DS} - Drain - Source Voltage (V)

Figure 1. Output Characteristics



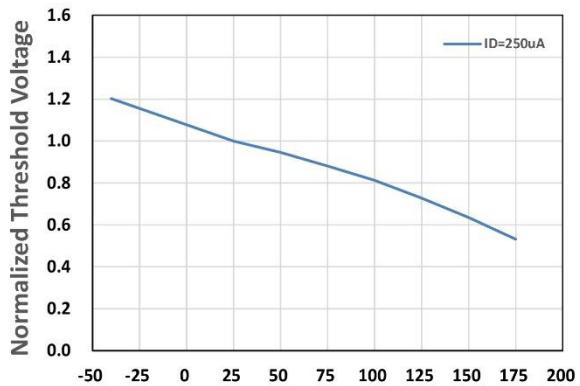
I_D - Drain Current (A)

Figure 2. On-Resistance vs. ID



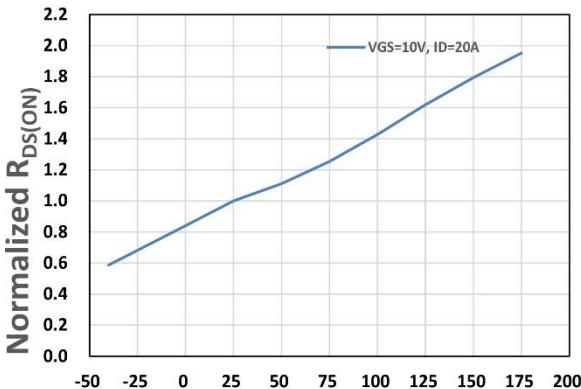
V_{GS} - Gate - Source Voltage (V)

Figure 3. On-Resistance vs. VGS



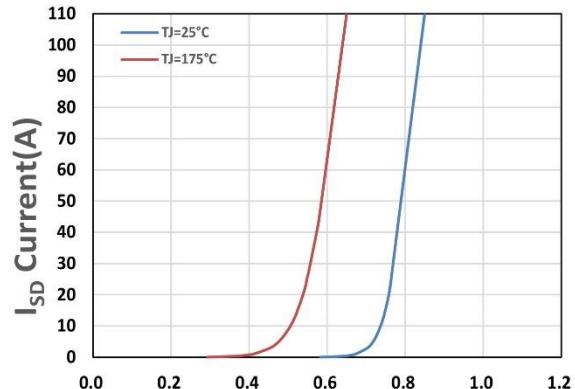
T_j , Junction Temperature(°C)

Figure 4. Gate Threshold Voltage



T_j , Junction Temperature(°C)

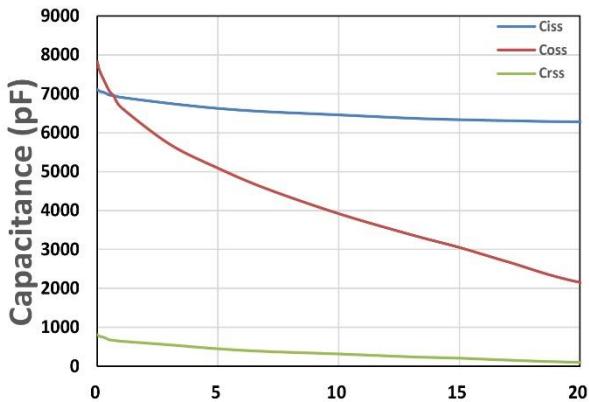
Figure 5. Drain-Source On Resistance



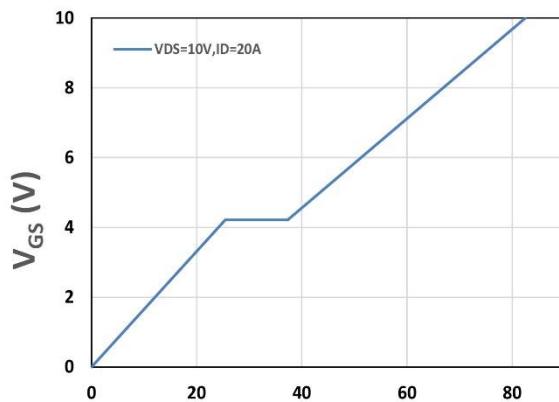
V_{SD} , Source-Drain Voltage(V)

Figure 6. Source-Drain Diode Forward

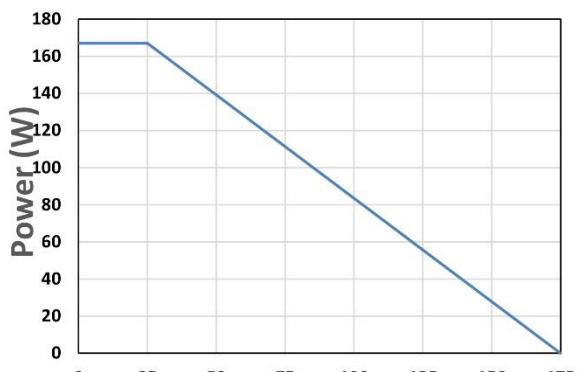
LM45010NHM8A



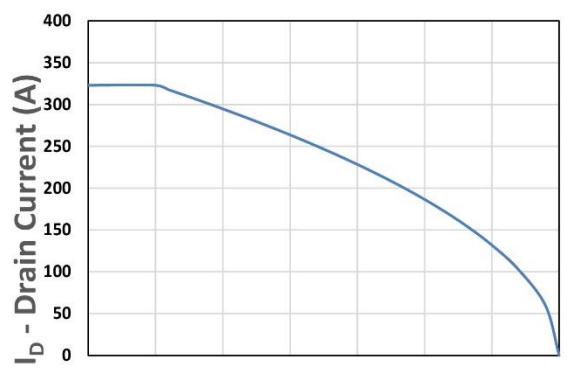
V_{DS} - Drain - Source Voltage (V)
Figure 7. Capacitance



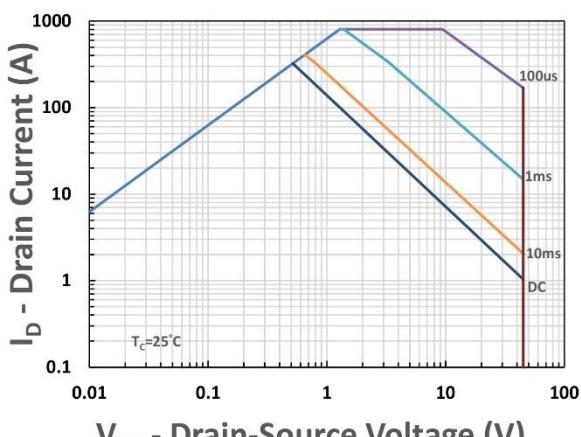
Q_g , Total Gate Charge (nC)
Figure 8. Gate Charge Characteristics



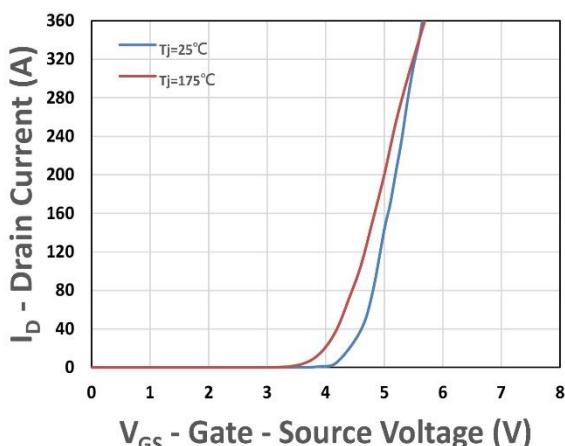
T_c -Case Temperature (°C)
Figure 9. Power Dissipation



T_c -Case Temperature (°C)
Figure 10. Drain Current



V_{DS} - Drain-Source Voltage (V)
Figure 11. Safe Operating Area



I_D - Drain Current (A)
 V_{GS} - Gate - Source Voltage (V)
Figure 12. Transfer Characteristics

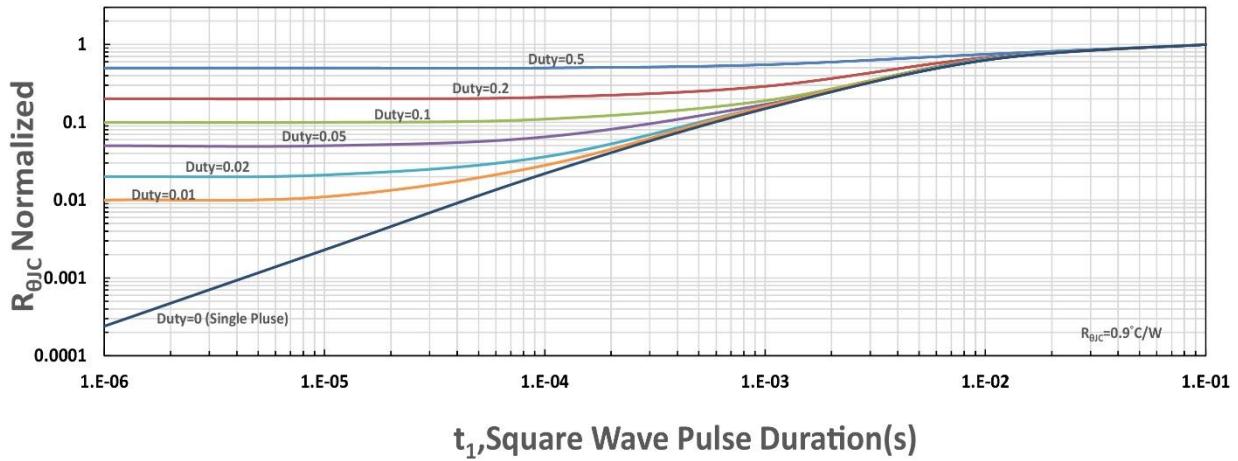


Figure 13. $R_{\theta jc}$ Transient Thermal Impedance